CMOS logic gates

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Resources and methods for learning about these subjects (list a few here, in preparation for your research):

Counting practice: count from zero to thirty-one in binary, octal, and hexadecimal:

		Binary	Octal	Hex
	Zero			
Γ	One			
Γ	Two			
Γ	Three			
	Four			
Γ	Five			
Γ	Six			
Γ	Seven			
Γ	Eight			
	Nine			
Γ	Ten			
Γ	Eleven			
Γ	Twelve			
Г	Thirteen			
	Fourteen			
Γ	Fifteen			

	Binary	Octal	Hex
Sixteen			
Seventeen			
Eighteen			
Nineteen			
Twenty			
Twenty one			
Twenty two			
Twenty three			
Twenty four			
Twenty five			
Twenty six			
Twenty seven			
Twenty eight			
Twenty nine			
Thirty			
Thirty one			

file 01221

Answer 1

No answers given here – compare with your classmates!

Notes 1

In order to familiarize students with these "strange" numeration systems, I like to begin each day of digital circuit instruction with counting practice. Students need to be *fluent* in these numeration systems by the time they are finished studying digital circuits!

One suggestion I give to students to help them see patterns in the count sequences is "pad" the numbers with leading zeroes so that all numbers have the same number of characters. For example, instead of writing "10" for the binary number two, write "00010". This way, the patterns of character cycling (especially binary, where each successively higher-valued bit has half the frequency of the one before it) become more evident to see.

Identify each of these logic gates by name, and complete their respective truth tables:

ut
)

A	Output
0	
1	

A	В	Output
0	0	
0	1	
1	0	
1	1	

A	В	Output	
0	0		
0	1		
1	0		
1	1		

A	В	Output
0	0	
0	1	
1	0	
1	1	

A	В	Output
0	0	
0	1	
1	0	
1	1	·

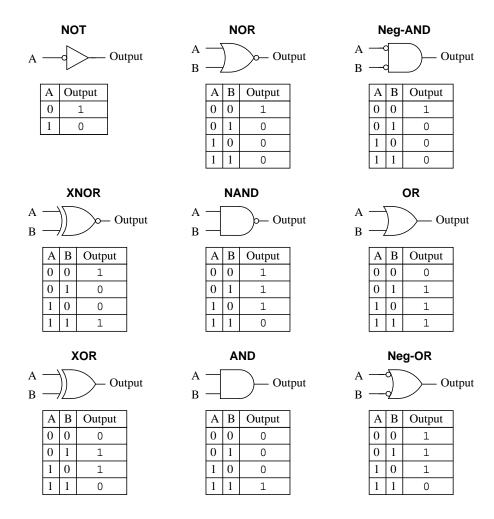
A	В	Output
0	0	
0	1	
1	0	
1	1	

A	В	Output
0	0	
0	1	
1	0	
1	1	

A	В	Output
0	0	
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1	1	

A	В	Output
0	0	
0	1	
1	0	
1	1	

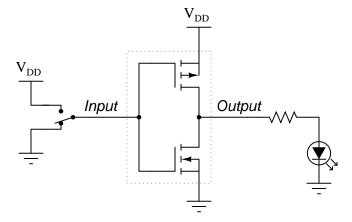
 $\underline{\mathrm{file}\ 02772}$



Notes 2

In order to familiarize students with the standard logic gate types, I like to given them practice with identification and truth tables each day. Students need to be able to recognize these logic gate types at a glance, or else they will have difficulty analyzing circuits that use them.

The simplest type of digital logic circuit is an *inverter*, also called an *inverting buffer*, or *NOT gate*. Here is a schematic diagram for an inverter gate constructed from complementary MOSFETs (CMOS), shown connected to a SPDT switch and an LED:



Determine the status of the LED in each of the input switch's two positions. Denote the logic level of switch and LED in the form of a truth table:

Input	Output

file 01254

Answer 3

Input	Output
Low	High
High	Low

Notes 3

Have your students explain the operation of this very simple MOSFET circuit, describing how the inverse logic state is generated at the output terminal, from a given input state. Discuss with your students the simplicity of the CMOS inverter, especially contrasted against a TTL inverter circuit.

In CMOS circuitry, one side of the DC power supply is usually labeled as " V_{DD} ", while the other side is labeled as " V_{SS} ". Why is this? What do the subscripts "DD" and "SS" represent?

file 01273

Answer 4

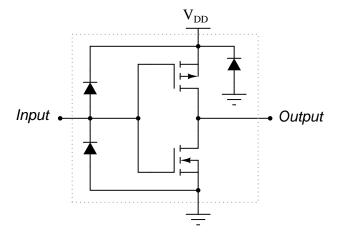
The labels V_{DD} and V_{SS} are supposed to mean "power supply to drain and source sides of MOSFETs, respectively. This nomenclature is actually a holdover from obsolete NMOS gate designs, which used N-channel MOSFETS exclusively. Even though it doesn't make much sense in CMOS circuits (you'll see why if you examine the internal schematic diagram for a CMOS gate), it is the standard way of denoting power supply terminals for CMOS circuits.

Follow-up question: what polarities do these respective labels represent?

Notes 4

Ahhh, the vestiges of yesterday's technology! What can I say? Sometimes terms "stick" even when it makes little sense for them to.

Practical CMOS logic gates contain more than just MOSFETs. Here is a schematic diagram for a typical inverter gate circuit, with protection diodes:



Explain what specific conditions each protection diode protects against. $\underline{{\rm file}~01255}$

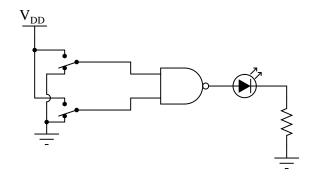
Answer 5

Two of the diodes protect against input voltages exceeding the supply rails, while the third diode protects against a reverse-connected power supply.

Notes 5

It is important that students realize these "protection" diodes do not allow circuit designers and builders to disregard good design practices with impunity. Ask your students, in each case, how each protection diode accomplishes its task of protecting the MOSFETs from damage. Does this mean the gate circuit will be able to withstand abnormal conditions indefinitely? Why or why not?

A student builds the following circuit to demonstrate the behavior of a NAND gate:



When the student tests the circuit, though, something is wrong:

- Both switches LOW, no light.
- One switch HIGH, the other switch LOW; LED lights up.
- One switch LOW, the other switch HIGH; LED lights up.
- Both switches HIGH, no light.

Instead of acting as a NAND gate should, it seems to behave as if it were an Exclusive-OR gate! Examining the circuit for mistakes, the student discovers missing power connections to the chip – in other words, neither V_{DD} nor V_{SS} are connected to the power source.

While this certainly is a problem, the student is left to wonder, "How did the circuit ever function at all?" With no power connected to the chip, how is it possible that the LED ever lit in any condition? file 01561

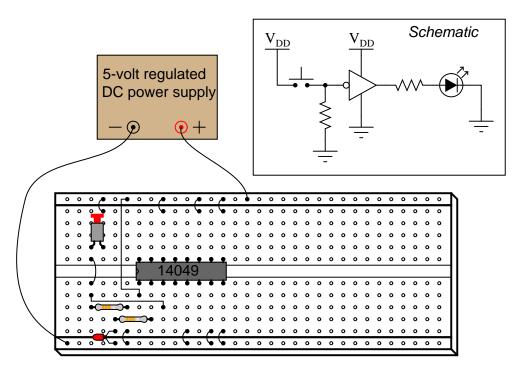
Answer 6

The chip's internal input protection diodes allowed the switch inputs to supply operating power to the MOSFET transistors.

Notes 6

As an instructor of electronics, I've seen students make this mistake countless times. What is particularly troublesome about this error is the seemingly intermittent behavior of the chip. Without power supplied to the chip, most students assume there would be no function at all. So when they see the chip functioning adequately in some of its circuit's states, they are inclined to assume power is not an issue!

A student builds the following digital circuit on a solderless breadboard (a "proto-board"):



The DIP circuit is a hex inverter (it contains six "inverter" or "NOT" logic gates), but only one of these gates is being used in this circuit. The student's intent was to build a logic circuit that energized the LED when the pushbutton switch was unactuated, and de-energized the LED when the switch was pressed: so that the LED indicates the reverse state of the switch itself. The student builds this circuit, and it is found to function perfectly well.

Explain the purpose of the resistor on the input of the inverter. What is it there for? What might happen if it were to be removed from the circuit?

Also, explain why the inputs of all the unused inverter gates in this IC have been either connected to ground or to V_{DD} . Is this necessary for the circuit to work properly, or is it just a precautionary measure? file 01253

Answer 7

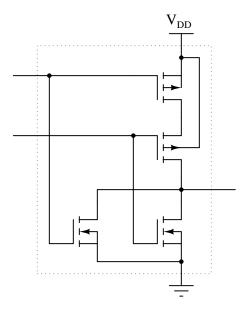
The resistor on the input side of the gate functions as a *pulldown*, to provide a solid "low" state to the gate's input when the switch contacts open.

Shorting all unused gate inputs to either ground or V_{DD} is merely a precautionary measure. It prevents unnecessary power draw from the supply, and possible IC overheating.

Notes 7

Discuss the problem of "floating" or "high-Z" states with your students, especially in the context of CMOS. What is it about the nature of a CMOS circuit that makes floating inputs especially troublesome? Ask your students to contrast this against floating TTL inputs.

The following is an internal schematic of a CMOS logic gate. Based on your analysis of the transistor circuit, determine what type of gate (AND, OR, NAND, NOR, XOR, etc.) it is:



file 01272

Answer 8

This is a NOR gate.

Follow-up question: identify a series of "thought experiments" you could perform on this circuit schematic to determine the identity of the gate. In other words, document what imagined conditions you would subject this gate to, and what the resulting output states would signify, in answering the question of what type of gate this is.

Notes 8

CMOS logic gate circuits are the easiest of all the gates to analyze internally! Discuss with your students why the second-from-the-top MOSFET uses an independent substrate connection (as opposed to making it common with the source, as usual).

What is the typical power supply voltage range for a CD4xxx series (or MC4xxx series) CMOS logic gate? How does this compare with the allowable power supply voltage range for a standard (5 volt) TTL logic gate? Consult a datasheet for your answer.

file 01274

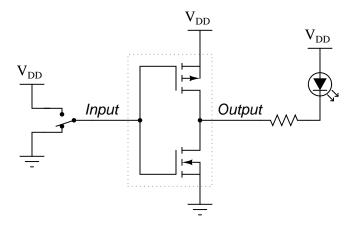
Answer 9

3 to 18 VDC is typical, though some integrated circuits may have slightly different ratings.

Notes 9

This question gets students in the habit of consulting datasheets to obtain information on logic gate circuits. Datasheets are a wealth of technical information, and students absolutely have to become adept at referencing them to obtain the information they need to build and troubleshoot logic circuits.

A very important concept to understand in digital circuitry is the difference between *current sourcing* and *current sinking*. For instance, examine this CMOS inverting buffer gate circuit, connected to a load:



Is this gate circuit configured to source load current, sink load current, or do both? file 01259

Answer 10

In this particular case, the way the load (LED) is connected to the output of the gate, the gate will only sink current. However, the gate is capable of sourcing current to a load, if only the load were connected differently.

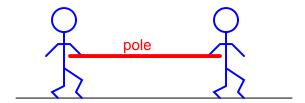
Follow-up question: re-draw the circuit to show the gate sourcing current to an LED load.

Notes 10

This very important concept is best understood from the perspective of *conventional* current flow notation. The terms seem backward when electron flow notation is used to track current through the output transistor.

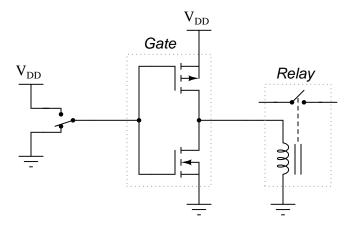
One point of confusion I've experienced among students is that current may go either direction (in or out) of a gate with totem-pole output transistors (able to sink or source current). Some students seem to have a conceptual difficulty with current going in to the output terminal of a gate circuit, because they mistakenly associate the "out" in output as being a reference to direction of current, rather than direction of information or data.

An analogy I've used to help students overcome this problem is that of two people carrying a long pole:



Suppose these people are in a dark, noisy room, and they use the pole as a means of simple communication between them. For example, one person could tug on the pole to get the other person's attention. Perhaps they could even develop a simple code system for communicating thoughts (1 tug = hello; 2 tugs = good-bye; 3 tugs = I think this is a silly way to communicate; 4 tugs = let's leave this room; etc.). If one of the persons pushes on the pole rather than pulls on the pole to get the other person's attention, does the direction of the pole's motion change the direction of the communication between the two persons? Of course not. Well, then, does the direction of current through the output terminal of a gate change the direction that information flows between two interconnected gates? Whether a gate sources current or sinks current to a load has no bearing on the "output" designation of that gate terminal. Either way, the gate is still "telling the load what to do" by exercising control over the load current.

Suppose that a CMOS inverting buffer gate were to drive a predominantly inductive load, such as a small relay coil:



Normally, it would be considered good design practice to connect a commutating diode in parallel with the relay coil, to prevent high-voltage transients when the coil is de-energized. However, this is not necessary when a CMOS gate drives a coil. Explain why.

file 01271

Answer 11

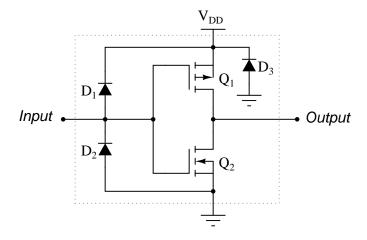
If you thought the answer to this question was, "because MOSFET transistors are immune to damage from high-voltage transients," you were wrong. If anything, MOSFETs are even more susceptible to damage from high-voltage transients than BJTs, given their thinly insulated gates.

The correct answer has to do with the *bilateral* (non polarity-sensitive) nature of MOSFETs when conducting. Trace the direction of current through the relay coil while energized, and at the point in time when the gate output switches to a "low" state, and you will understand why no commutating diode is necessary in this circuit.

Notes 11

By examining one of the ancillary benefits of using CMOS instead of TTL, students get a good review of inductor and transistor theory. Ask your students to explain why a TTL gate *would* require the relay coil to have a commutating diode, lest the gate be destroyed by inductive "kickback."

Predict how the operation of this logic gate circuit will be affected as a result of the following faults. Consider each fault independently (i.e. one at a time, no multiple faults):



- Diode D_1 fails open:
- Diode D_1 fails shorted:
- Diode D_2 fails open:
- Diode D_2 fails shorted:
- Transistor Q_1 fails open (drain to source):
- Transistor Q_2 fails open (drain to source):

For each of these conditions, explain $\it why$ the resulting effects will occur. file 03824

Answer 12

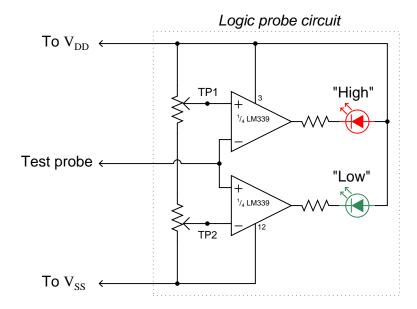
- Diode D_1 fails open: No effect.
- Diode D_1 fails shorted: Output always in low state, possible damage to circuit when input is forced low by another gate (or switch).
- Diode D_2 fails open: No effect.
- Diode D_2 fails shorted: Output always in high state, possible damage to circuit when input is forced high by another gate (or switch).
- Transistor Q_1 fails open (drain to source): Output cannot source current in high state, but is still able to sink current in low state.
- Transistor Q_2 fails open (drain to source): Output cannot sink current in low state, but is still able to source current in high state.

Notes 12

The purpose of this question is to approach the domain of circuit troubleshooting from a perspective of knowing what the fault is, rather than only knowing what the symptoms are. Although this is not necessarily a realistic perspective, it helps students build the foundational knowledge necessary to diagnose a faulted circuit from empirical data. Questions such as this should be followed (eventually) by other questions asking students to identify likely faults based on measurements.

A *logic probe* is a very useful tool for working with digital logic circuits. It indicates "high" and "low" logic states by means of LED's, giving visual indication only if the voltage levels are appropriate for each state

Here is a schematic diagram for a logic probe built using comparators. Each comparator has a threshold adjustment potentiometer, so that it may be set to indicate its respective logic state only if the signal voltage is well within the range stated by the logic manufacturer:



When this logic probe circuit is connected to the V_{DD} and V_{SS} power supply terminals of a powered CMOS circuit, what voltage levels should test points TP1 and TP2 be adjusted to, in order for the probe to properly indicate "high" and "low" CMOS logic states? Consult a datasheet for the quad NAND gate numbered 4011. This is a legacy CMOS integrated circuit. file 01275

Answer 13

I'll let you do your own research on this question. DO NOT obtain your answer from a textbook, but consult a manufacturer's datasheet instead! You will find that the acceptable voltage levels vary with the power supply voltage, but that the *percentages* are rather constant.

Follow-up question: write a formula for calculating appropriate current-limiting resistor sizes for the two LEDs in this circuit, given the value of +V and the LED forward voltage and current values.

Challenge question: the logic probe circuit shown is minimal in component count. To make a more practical and reliable probe, one would probably want to have reverse-polarity protection (in case someone were to accidently connect the probe backward across the power supply) as well as decoupling for immunity against electrical noise. Add whatever necessary components you think there should be in this circuit to provide these features.

Notes 13

The most obvious lesson of this question is to introduce (or review as the case may be) the purpose and operation of a logic probe. However, this question is also a veiled introduction (or review) of CMOS logic levels.

What logic state does a floating CMOS gate input naturally assume? How does this compare against traditional TTL?

file 02865

Answer 14

A floating CMOS gate does not assume any definite logic state! The logic state of a floating CMOS gate input is indeterminate.

Follow-up question: what state does a floating input assume for a high-speed CMOS (74HCxx) logic gate, which is designed to be an upgrade/replacement for traditional TTL gates?

Notes 14

Ask your students to explain their answer based on an analysis of the internals of a CMOS gate, versus the internals of a TTL gate. Memorization is not good enough – students must grasp why these different logic families behave as they do.

As an electronics instructor, I have the opportunity to see a lot of creative mistakes made by students as they learn to build circuits. One very common mistake made in CMOS circuit construction manifests itself in erratic behavior: the circuit may function correctly for a time, but suddenly and randomly it stops. Then, just by waving your hand next to the circuit, it begins to work again!

This problem is especially prevalent on days where the atmospheric humidity is low, and static electric charges easily accumulate on objects and people. Explain what sort of CMOS wiring mistake would cause a powered logic gate to behave erratically due to nearby static electric fields, and what the proper solution is to this problem.

file 01278

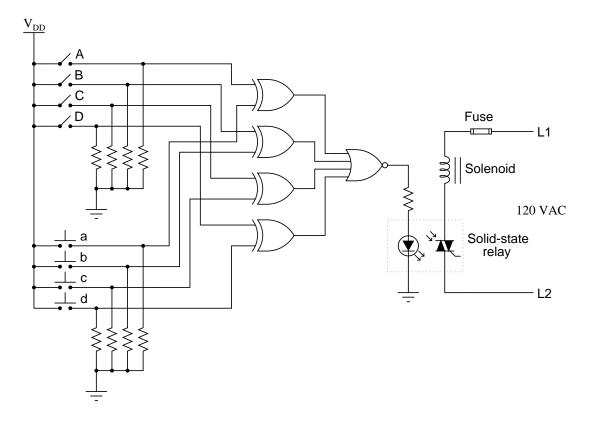
Answer 15

This classic problem is caused by a lack of pullup or pulldown resistors on CMOS gate inputs.

Notes 15

Students think I'm a wizard by being able to troubleshoot their CMOS circuits just by waving my hand next to them. No, I'm just wise in the ways of common student error!

Here is a schematic diagram for a simple electronic combination lock, controlling power to a door lock solenoid:



The four pushbutton switches (a, b, c, and d) are accessible to the person wishing to enter the door. The four toggle switches (A, B, C, and D) are located behind the door, and are used to set the code necessary for entering.

Explain how this system is supposed to work. What are the logic states of the respective gate outputs when a matching code is entered through the pushbutton switches? How about when a non-matching code is entered?

Do you see any security problems with this door lock circuit? How easy would it be for someone to enter, who does not know the four-bit code? Do you have any suggestions for improving this lock design? file 01277

Answer 16

The most obvious problem with this door lock system is the small number of possible codes. It would be rather easy (especially for someone adept at counting in binary!) to simply try all the possible combinations until they gained access.

Here is what I recommend as a strategy for improving the level of security offered by this system: install a fifth pushbutton switch as an "Enter" key. If someone enters the correct four-bit code and then pushes the "Enter" button, the door will open. However, if someone enters the wrong four-bit code and pushes the "Enter" button, the door will not open and a loud alarm will sound! This makes it "risky" to enter a wrong code, thus improving the security of the system.

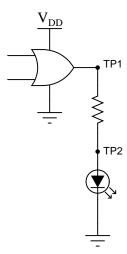
Follow-up question: modify the circuit shown to implement an improved measure of security – either the strategy suggested or one of your own design.

Notes 16

I strongly suggest you take the time to implement an improved-security design with your students. A practical project such as this sparks a lot of interest, and thus provides an excellent learning opportunity.

Not only does this question afford the opportunity to analyze logic gates, but it also provides a context in which to review optocouplers and TRIACs. Ask your students what the labels "L1" and "L2" mean, with reference to AC power circuitry, as well.

Logic probes are useful tools for troubleshooting digital logic gate circuits, but they certainly have limitations. For instance, in this simple circuit, a logic probe will give correct "high" and "low" readings at test point 1 (TP1), but it will always read "low" (even when the LED is on) at test point 2 (TP2):



Now, obviously the output of the gate is "high" when the LED is on, otherwise it would not receive enough voltage to illuminate. Why then does a logic probe fail to indicate a high logic state at TP2? file 02866

Answer 17

I won't give away the answer here, but it has something to do with proper CMOS logic level voltages.

Follow-up question: this LED circuit is rather simple, and the scenario almost silly, because the LED's presence makes checking the logic state at TP1 and TP2 superfluous! Can you think of any other circuit or situation where a similar false reading may be displayed by a logic probe – where the logic state has not been made visually obvious by the presence of an LED?

Notes 17

It is easy for students to overlook the limitations of a logic probe, and to forget what actually drives it to say "high" or "low" when measuring a logic level. This is why in low-speed circuits I prefer to use a good digital voltmeter rather than a logic probe to discern logic states. With a voltmeter, you can see exactly what the voltage level is, and determine whether or not the logic state is marginal.

In high-speed digital circuits, a very important logic gate parameter is *propagation delay*: the delay time between a change-of-state on a gate's input and the corresponding change-of-state on that gate's output. Consult a manufacturer's datasheet for any CMOS logic gate and report the typical propagation delay times published there.

Also, explain what causes propagation delay in logic gates. Why isn't the change in output state instantaneous when an input changes states?

file 01276

Answer 18

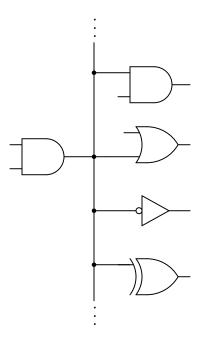
I'll leave the research of specific propagation time delay figures up to you! The reason propagation delay exists is because transistors cannot turn on and turn off instantaneously. In insulated-gate field-effect transistors, this is primarily due to the time required to charge or discharge the gate-to-channel capacitance.

Follow-up questions: What difference is there between high-to-low output transitions versus low-to-high output transitions for the gate you researched? Which transition is faster?

Notes 18

I purposely omitted answers for this question, not only because I want students to do the research on their own, but also because it makes it more interesting when students consult different datasheets and derive different answers (for different logic "families")!

Logic gates are limited in the number of gate inputs which one output can reliably drive. This limit is referred to as fan-out:



Explain why this limit exists. What is it about the construction of CMOS logic gates that inherently limits the number of CMOS inputs that any one CMOS output can drive? What might happen if this limit is exceeded?

Fan-out for CMOS is a quite different than fan-out for TTL. Most importantly is that CMOS fan-out is inversely proportional to operating frequency. Explain why.

file 01268

Answer 19

A fan-out limit for CMOS exists because CMOS outputs have to source and sink *capacitive* charging and discharging current from the CMOS inputs. I'll let you determine why this limit is frequency-dependent.

Notes 19

For the relatively simple digital circuits that beginning students build, fan-out is rarely a problem. More likely is that students will try to drive a load that is too "heavy," causing the same voltage level problem.

An important parameter of logic gate circuitry is *noise margin*. What exactly is "noise margin," and how is it defined for logic gates?

Specifically, how much noise margin do digital circuits exclusively composed of CMOS gates have? How does this compare with the noise margin of all-TTL circuitry?

Note: you will need to consult CMOS gate datasheets to answer this question properly. file 01270

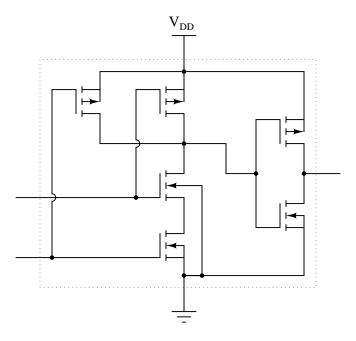
Answer 20

Noise margin is the difference between the acceptable voltage limits for corresponding input and output logic states.

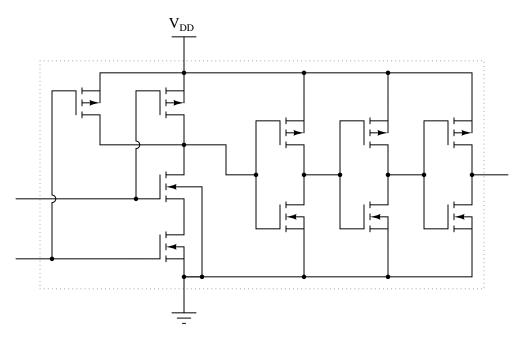
Notes 20

This question, to be answered properly, involves more than just a definition of "noise margin." Students must first discover that there is a difference between voltage compliance levels for gate inputs versus outputs, then recognize that the difference constitutes a "margin" that imposed AC voltage ("noise") must not exceed. They must then present their answer in terms of manufacturer specifications, obtained in datasheets. In summary, there is a lot of research that must occur to answer this question, but the results will be worth it!

Many modern CMOS gate circuits are buffered with additional transistor stages on their outputs. For example, an unbuffered AND gate is shown here, with no more transistors than is necessary to fulfill the "AND" logic function:



One type of "buffered" CMOS AND gate looks like this:



As far as the basic logic function is concerned, the additional transistors are unnecessary. However, the "buffering" they provide does serve a useful function. What is that function? Are there any disadvantages to buffered logic gates, versus unbuffered?

file 01280

Answer 21

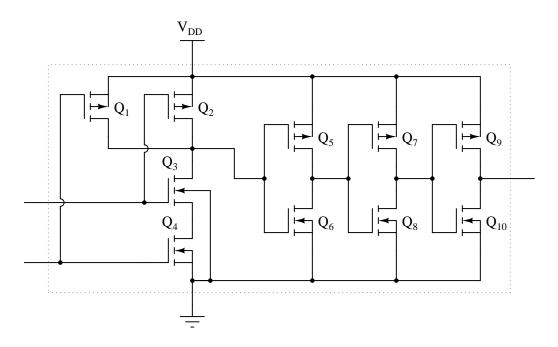
Buffered gates exhibit better noise immunity than unbuffered gates. One disadvantage to buffering, though, is increased propagation delay time.

Follow-up question: identify the on/off states of all transistors in the buffered circuit for both (high and low) input conditions.

Notes 21

Texas Instruments publishes an excellent application report ($SCHA004 - October\ 2002$) comparing buffered versus unbuffered CMOS logic gates. I highly recommend it for your reference.

Identify at least three different transistor faults in this CMOS logic gate that could cause the output to fail low:



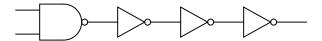
file 03825

Answer 22

- Transistor Q_1 failed shorted (drain to source).
- Transistor Q_4 failed open (drain to source).
- Transistor Q_5 failed open (drain to source).
- Transistor Q_{10} failed shorted (drain to source).

Notes 22

One way for students to approach this problem is to re-draw the schematic in gate symbol form, a NAND gate followed by three inverters:



Discuss with them why this approach may be helpful in determining possible component faults in the integrated circuit.

What does it mean if you see a logic gate symbol in a schematic diagram with a strange-looking "S" figure drawn inside of it?



file 01281

Answer 23

The "S" figure, which resembles a magnetic B-H hysteresis curve, marks this gate as a *Schmitt trigger*. I'll let you do the research to determine what this means in regard to gate function.

Notes 23

Schmitt trigger gates are indispensable for certain logic circuit applications. It is important that students recognize their function and utility.

Incidentally, this question provides a good opportunity to review magnetic hysteresis curves, since it's probably been awhile since students last studied electromagnetism theory!

A problem unique to certain types of CMOS logic gates is something called *SCR latchup*. This is an abnormal condition capable of ruining a circuit, or at the very least causing operational problems in a circuit. Explain what this phenomenon is, and what causes it.

file 01248

Answer 24

If an input or output of a CMOS gate circuit is driven above V_{DD} , even momentarily, the circuit may "latch" like an SCR, causing V_{DD} to become shorted to V_{SS} internally. This is made possible by the way CMOS transistors are manufactured on the integrated circuit's substrate.

Challenge question: referencing a cross-sectional illustration of a CMOS gate integrated circuit, show the "SCR" formed by the transistors, and explain how it may be "fired" by excessive input voltage to the gate.

Notes 24

Based on their knowledge of thyristors, your students should be able to tell you how to best "unlatch" a CMOS gate stuck in this condition. Challenge them with this problem, and also with the question of how one might detect such a condition as it's happening.

Mention to your students that not all CMOS families exhibit this problem, and that manufacturers have been keen to address serious design faults such as these. If nothing else, though, this should reinforce the lesson that one should *never* exceed the supply rail voltage for any type of active circuit, be it an op-amp, gate, or something else, unless expressly permitted by the manufacturer.

A trend in CMOS logic gate development is toward lower and lower operating voltages. The "AUC" family of CMOS logic, for example, is able to operate at less than 2 volts V_{DD} !

Explain why this is a trend in modern logic circuit design. What benefits result from lower operating voltages? What possible disadvantages also result?

file 01279

Answer 25

Lower operating voltages result in less power dissipation. However, noise margins become "tighter" under the same conditions, which is a disadvantage.

Notes 25

Discuss this trend with your students, citing examples from industry literature if possible. Be sure to ask your students why lower operating voltages reduces power dissipation (with reference to Joule's Law, please!), and also why this reduces noise margins.

In the early days of solid-state logic gate circuit technology, there was a very clear distinction between TTL and CMOS. TTL gates were capable of switching on and off very fast, required a tightly regulated power supply voltage, and used a lot of power. CMOS gates were not quite as fast as TTL, but could tolerate a much wider range of power supply voltages and were far less wasteful on power.

Then, during the 1980's a new technology known as *high-speed CMOS*, or HCMOS, entered the scene. Explain what HCMOS is, how it compares to the older TTL and CMOS families (54/74xx and 4xxx number series, respectively), and where it is often used. Hint: high-speed CMOS bears the same numerical codes as the old TTL 54xx and 74xx series ICs (e.g. 74HC00 instead of 7400).

file 02773

Answer 26

I'll let you research the answer to this question!

Notes 26

High-speed CMOS was a very important developmental milestone in digital logic gate technology, and it is essential for modern (2005) students of electronics to be aware of since it is so widely used. In many ways it blends the best of the old TTL and CMOS worlds, with few disadvantages.

Don't just sit there! Build something!!

Learning to analyze digital circuits requires much study and practice. Typically, students practice by working through lots of sample problems and checking their answers against those provided by the textbook or the instructor. While this is good, there is a much better way.

You will learn much more by actually *building and analyzing real circuits*, letting your test equipment provide the "answers" instead of a book or another person. For successful circuit-building exercises, follow these steps:

- 1. Draw the schematic diagram for the digital circuit to be analyzed.
- 2. Carefully build this circuit on a breadboard or other convenient medium.
- 3. Check the accuracy of the circuit's construction, following each wire to each connection point, and verifying these elements one-by-one on the diagram.
- 4. Analyze the circuit, determining all output logic states for given input conditions.
- 5. Carefully measure those logic states, to verify the accuracy of your analysis.
- 6. If there are any errors, carefully check your circuit's construction against the diagram, then carefully re-analyze the circuit and re-measure.

Always be sure that the power supply voltage levels are within specification for the logic circuits you plan to use. If TTL, the power supply must be a 5-volt regulated supply, adjusted to a value as close to 5.0 volts DC as possible.

One way you can save time and reduce the possibility of error is to begin with a very simple circuit and incrementally add components to increase its complexity after each analysis, rather than building a whole new circuit for each practice problem. Another time-saving technique is to re-use the same components in a variety of different circuit configurations. This way, you won't have to measure any component's value more than once.

file 00805

Answer 27

Let the electrons themselves give you the answers to your own "practice problems"!

Notes 27

It has been my experience that students require much practice with circuit analysis to become proficient. To this end, instructors usually provide their students with lots of practice problems to work through, and provide answers for students to check their work against. While this approach makes students proficient in circuit theory, it fails to fully educate them.

Students don't just need mathematical practice. They also need real, hands-on practice building circuits and using test equipment. So, I suggest the following alternative approach: students should *build* their own "practice problems" with real components, and try to predict the various logic states. This way, the digital theory "comes alive," and students gain practical proficiency they wouldn't gain merely by solving Boolean equations or simplifying Karnaugh maps.

Another reason for following this method of practice is to teach students *scientific method*: the process of testing a hypothesis (in this case, logic state predictions) by performing a real experiment. Students will also develop real troubleshooting skills as they occasionally make circuit construction errors.

Spend a few moments of time with your class to review some of the "rules" for building circuits before they begin. Discuss these issues with your students in the same Socratic manner you would normally discuss the worksheet questions, rather than simply telling them what they should and should not do. I never cease to be amazed at how poorly students grasp instructions when presented in a typical lecture (instructor monologue) format!

I highly recommend CMOS logic circuitry for at-home experiments, where students may not have access to a 5-volt regulated power supply. Modern CMOS circuitry is far more rugged with regard to static discharge than the first CMOS circuits, so fears of students harming these devices by not having a "proper" laboratory set up at home are largely unfounded.

A note to those instructors who may complain about the "wasted" time required to have students build real circuits instead of just mathematically analyzing theoretical circuits:

What is the purpose of students taking your course?

If your students will be working with real circuits, then they should learn on real circuits whenever possible. If your goal is to educate theoretical physicists, then stick with abstract analysis, by all means! But most of us plan for our students to do something in the real world with the education we give them. The "wasted" time spent building real circuits will pay huge dividends when it comes time for them to apply their knowledge to practical problems.

Furthermore, having students build their own practice problems teaches them how to perform *primary* research, thus empowering them to continue their electrical/electronics education autonomously.

In most sciences, realistic experiments are much more difficult and expensive to set up than electrical circuits. Nuclear physics, biology, geology, and chemistry professors would just love to be able to have their students apply advanced mathematics to real experiments posing no safety hazard and costing less than a textbook. They can't, but you can. Exploit the convenience inherent to your science, and get those students of yours practicing their math on lots of real circuits!